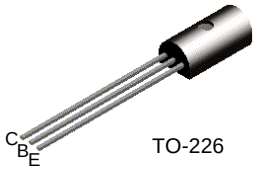
FAIRCHILD
SEMICONDUCTOR®

FPN660/FPN660A

PNP Low Saturation Transistor

- These devices are designed for high current gain and low saturation voltage with collector currents up to 3.0A continuous.
- Sourced from process PA.



TO-226

Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter	FPN660	FPN660A	Units
V_{CEO}	Collector-Emitter Voltage	60	60	V
V_{CBO}	Collector-Base Voltage	80	60	V
V_{EBO}	Emitter-Base Voltage	5	5	V
I_C	Collector Current - Continuous	3	3	A
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 ~ +150	-55 ~ +150	°C

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:
1) These ratings are based on a maximum junction temperature of 150°C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
3) All voltage (V) and currents (A) are negative polarity for PNP transistors

Electrical Characteristics T_A=25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
Off Characteristics							
BV_{CEO}	Collector-Emitter Breakdown Voltage	I_C = 10mA, I_B = 0		55			V
BV_{CBO}	Collector-Base Breakdown Voltage	I_E = 100µA, I_E = 0	FPN660	80			V
			FPN660A	60			V
BV_{EBO}	Emitter-Base Breakdown Voltage	I_E = 100µA, I_C = 0		5.0			V
I_{CBO}	Collector-Base Cutoff Current	V_{CB} = 30V, I_E = 0				100	nA
		V_{CB} = 30V, I_E = 0, T_A = 100°C				10	µA
I_{EBO}	Emitter-Base Cutoff Current	V_{EB} = 4.0V, I_C = 0				100	nA
On Characteristics *							
h_{FE}	DC Current Gain	I_C = 100mA, V_{CE} = 2.0V		70			
		I_C = 500mA, V_{CE} = 2.0V	FPN660	100		300	
			FPN660A	250		550	
		I_C = 1.0A, V_{CE} = 2.0V		80			
		I_C = 2.0A, V_{CE} = 2.0V		40			
V_{CE}(sat)	Collector-Emitter Saturation Voltage	I_C = 1.0A, I_B = 100mA				300	mV
		I_C = 2.0A, I_B = 200mA	FPN660			450	mV
			FPN660A			400	mV
V_{BE}(sat)	Base-Emitter Saturation Voltage	I_C = 1.0A, I_B = 100mA				1.25	V
V_{BE}(on)	Base-Emitter On Voltage	I_C = 1.0A, V_{CE} = 2.0V				1.0	V
Small Signal Characteristics							
C_{obo}	Output Capacitance	V_{CB} = 10V, I_E = 0, f = 1MHz				45	pF
f_T	Transition Frequency	I_C = 100mA, V_{CE} = 5.0V, f = 100MHz		75			MHz

* Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2.0%

NOTE: All voltage (V) and currents (A) are negative polarity for PNP transistors.

Thermal Characteristics T_A=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
		FPN660/FPN660A	
P_D	Total Device Dissipation	1	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	°C/W

Typical Characteristics

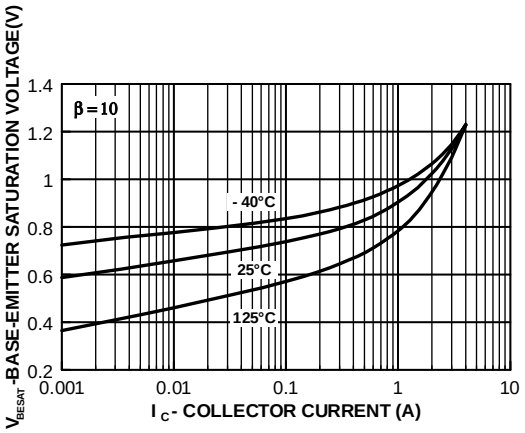


Figure 1. Base-Emitter Saturation Voltage vs Collector Current

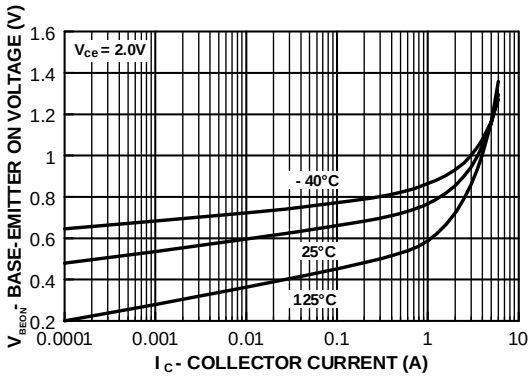


Figure 2. Base-Emitter On Voltag vs Collector Current

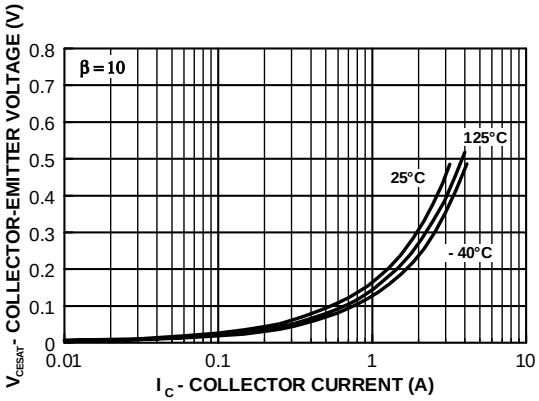


Figure 3. Collector-Emitter Saturation Voltage vs Collector Current

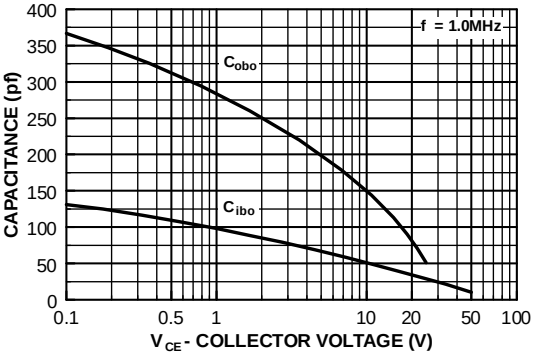


Figure 4. Input/Output Capacitance vs Reverse Bias Voltage

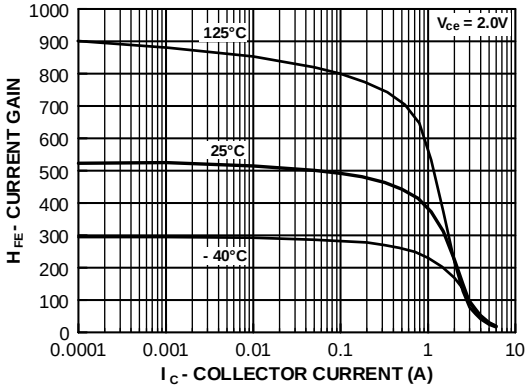


Figure 5. Current Gain vs Collector Current

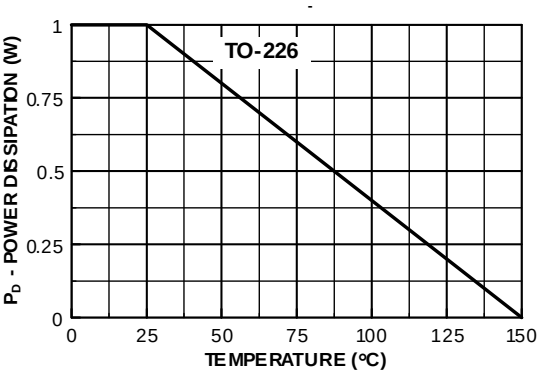


Figure 6. Power Dissipation vs Ambient Temperature

Package Dimensions

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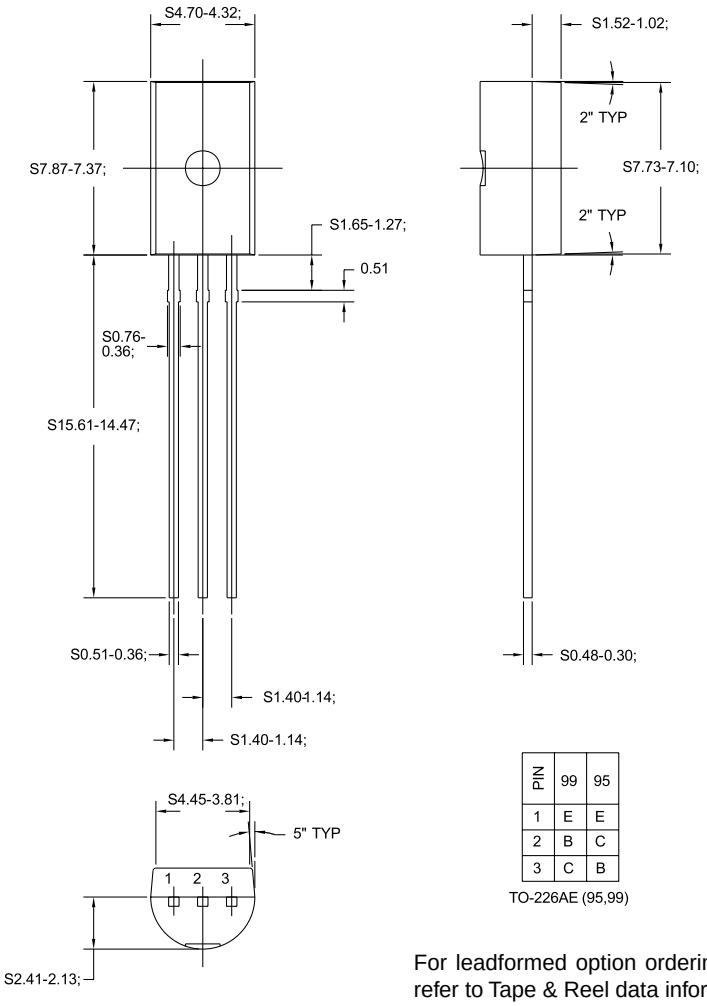

PIN	99	95
1	E	E
2	B	C
3	C	B

TO-226AE (95,99)

For leadformed option ordering,
refer to Tape & Reel data information.

Dimensions in Millimeters

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CoolFET™	FASTr™	MicroFET™	PowerTrench®	SuperSOT™-6
CROSSVOLT™	FRFET™	MicroPak™	QFET™	SuperSOT™-8
DOME™	GlobalOptoisolator™	MICROWIRE™	QS™	SyncFET™
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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
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